

LM324S, LM2902S

Single Supply Quad Operational Amplifiers

The LM324S and LM2902S are low-cost, quad operational amplifiers with true differential inputs. They have several distinct advantages over standard operational amplifier types in single supply applications. The common mode input range includes the negative supply, thereby eliminating the necessity for external biasing components in many applications. The output voltage range also includes the negative power supply voltage.

Features

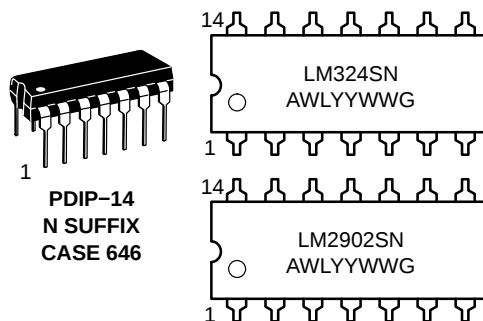
- Short Circuited Protected Outputs
- True Differential Input Stage
- Single Supply Operation: 3.0 V to 32 V
- Four Amplifiers Per Package
- Internally Compensated
- Common Mode Range Extends to Negative Supply
- Industry Standard Pinouts
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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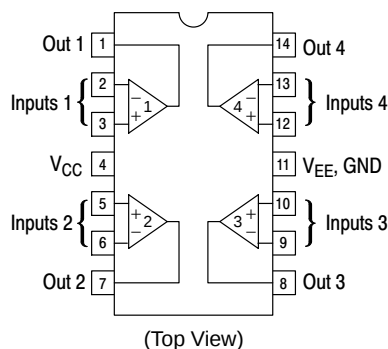
<http://onsemi.com>

MARKING DIAGRAMS



LMxxxx = Specific Device Code
A = Assembly Location
WL = Wafer Lot
Y, YY = Year
WW = Work Week
G = Pb-Free Package

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

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MAXIMUM RATINGS (T_A = +25°C, unless otherwise noted.)

Rating	Symbol	Value	Unit
Power Supply Voltages	Single Supply	V _{CC}	32
	Split Supplies	V _{CC} , V _{EE}	±16
Input Differential Voltage Range (Note 1)	V _{IDR}	±32	Vdc
Input Common Mode Voltage Range (Note 2)	V _{ICR}	−0.3 to 32	Vdc
Output Short Circuit Duration	t _{SC}	Continuous	
Junction Temperature	T _J	150	°C
Thermal Resistance, Junction-to-Air (Note 3)	Case 646	R _{θJA}	118
Storage Temperature Range	T _{stg}	−65 to +150	°C
Operating Ambient Temperature Range	T _A	LM324S	0 to +70
		LM2902S	−40 to +105

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Split Power Supplies.
2. For supply voltages less than 32 V, the absolute maximum input voltage is equal to the supply voltage.
3. All R_{θJA} measurements made on evaluation board with 1 oz. copper traces of minimum pad size. All device outputs were active.

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ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0\text{ V}$, $V_{EE} = \text{GND}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

Characteristics	Symbol	LM324S			LM2902S			Unit
		Min	Typ	Max	Min	Typ	Max	
Input Offset Voltage $V_{CC} = 5.0\text{ V}$ to 30 V , $V_{ICR} = 0\text{ V}$ to $V_{CC} - 1.7\text{ V}$, $V_O = 1.4\text{ V}$, $R_S = 0\ \Omega$ $T_A = 25^\circ\text{C}$ $T_A = T_{\text{high}}$ (Note 4) $T_A = T_{\text{low}}$ (Note 4)	V_{IO}	–	2.0	7.0	–	2.0	7.0	mV
Average Temperature Coefficient of Input Offset Voltage $T_A = T_{\text{high}}$ to T_{low} (Notes 4 and 6)	$\Delta V_{IO}/\Delta T$	–	7.0	–	–	7.0	–	$\mu\text{V}/^\circ\text{C}$
Input Offset Current $T_A = T_{\text{high}}$ to T_{low} (Note 4)	I_{IO}	–	5.0	50	–	5.0	50	nA
Average Temperature Coefficient of Input Offset Current $T_A = T_{\text{high}}$ to T_{low} (Notes 4 and 6)	$\Delta I_{IO}/\Delta T$	–	10	–	–	10	–	$\text{pA}/^\circ\text{C}$
Input Bias Current $T_A = T_{\text{high}}$ to T_{low} (Note 4)	I_{IB}	–	–90	–250	–	–90	–250	nA
Input Common Mode Voltage Range (Note 5) $V_{CC} = 30\text{ V}$ $T_A = +25^\circ\text{C}$ $T_A = T_{\text{high}}$ to T_{low} (Note 4)	V_{ICR}	0	–	28.3	0	–	28.3	V
Differential Input Voltage Range	V_{IDR}	–	–	V_{CC}	–	–	V_{CC}	V
Large Signal Open Loop Voltage Gain $R_L = 2.0\text{ k}\Omega$, $V_{CC} = 15\text{ V}$, for Large V_O Swing $T_A = T_{\text{high}}$ to T_{low} (Note 4)	A_{VOL}	25	100	–	25	100	–	V/mV
Channel Separation $10\text{ kHz} \leq f \leq 20\text{ kHz}$, Input Referenced	CS	–	–120	–	–	–120	–	dB
Common Mode Rejection, $R_S \leq 10\text{ k}\Omega$	CMR	65	70	–	50	70	–	dB
Power Supply Rejection	PSR	65	100	–	50	100	–	dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. LM324S: $T_{\text{low}} = 0^\circ\text{C}$, $T_{\text{high}} = +70^\circ\text{C}$

LM2902S: $T_{\text{low}} = -40^\circ\text{C}$, $T_{\text{high}} = +105^\circ\text{C}$

5. The input common mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is $V_{CC} - 1.7\text{ V}$, but either or both inputs can go to +32 V without damage, independent of the magnitude of V_{CC} .

6. Guaranteed by design.

LM324S, LM2902S

ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0\text{ V}$, $V_{EE} = \text{GND}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

Characteristics	Symbol	LM324S			LM2902S			Unit
		Min	Typ	Max	Min	Typ	Max	
Output Voltage – High Limit $V_{CC} = 5.0\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $T_A = 25^\circ\text{C}$ $V_{CC} = 30\text{ V}$, $R_L = 2.0\text{ k}\Omega$, ($T_A = T_{\text{high}}$ to T_{low}) (Note 7) $V_{CC} = 30\text{ V}$, $R_L = 10\text{ k}\Omega$, ($T_A = T_{\text{high}}$ to T_{low}) (Note 7)	V_{OH}	3.3 26 27	3.5 – 28	– – –	3.3 26 27	3.5 – 28	– – –	V
Output Voltage – Low Limit, $V_{CC} = 5.0\text{ V}$, $R_L = 10\text{ k}\Omega$, $T_A = T_{\text{high}}$ to T_{low} (Note 7)	V_{OL}	–	5.0	20	–	5.0	100	mV
Output Source Current ($V_{ID} = +1.0\text{ V}$, $V_{CC} = 15\text{ V}$) $T_A = 25^\circ\text{C}$ $T_A = T_{\text{high}}$ to T_{low} (Note 7)	I_{O+}	20 10	40 20	– –	20 10	40 20	– –	mA
Output Sink Current $V_{ID} = -1.0\text{ V}$, $V_{CC} = 15\text{ V}$, $T_A = 25^\circ\text{C}$ $T_A = T_{\text{high}}$ to T_{low} (Note 7) $V_{ID} = -1.0\text{ V}$, $V_O = 200\text{ mV}$, $T_A = 25^\circ\text{C}$	I_{O-}	10 5.0 12	20 8.0 50	– – –	10 5.0 –	20 8.0 –	– – –	mA μA
Output Short Circuit to Ground (Note 8)	I_{SC}	–	40	60	–	40	60	mA
Power Supply Current ($T_A = T_{\text{high}}$ to T_{low}) (Note 7) $V_{CC} = 30\text{ V}$, $V_O = 0\text{ V}$, $R_L = \infty$ $V_{CC} = 5.0\text{ V}$, $V_O = 0\text{ V}$, $R_L = \infty$	I_{CC}	– –	– –	3.0 1.2	– –	– –	3.0 1.2	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

7. LM324S: $T_{\text{low}} = 0^\circ\text{C}$, $T_{\text{high}} = +70^\circ\text{C}$

LM2902S: $T_{\text{low}} = -40^\circ\text{C}$, $T_{\text{high}} = +105^\circ\text{C}$

8. The input common mode voltage or either input signal voltage should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is $V_{CC} - 1.7\text{ V}$, but either or both inputs can go to $+32\text{ V}$ without damage, independent of the magnitude of V_{CC} .

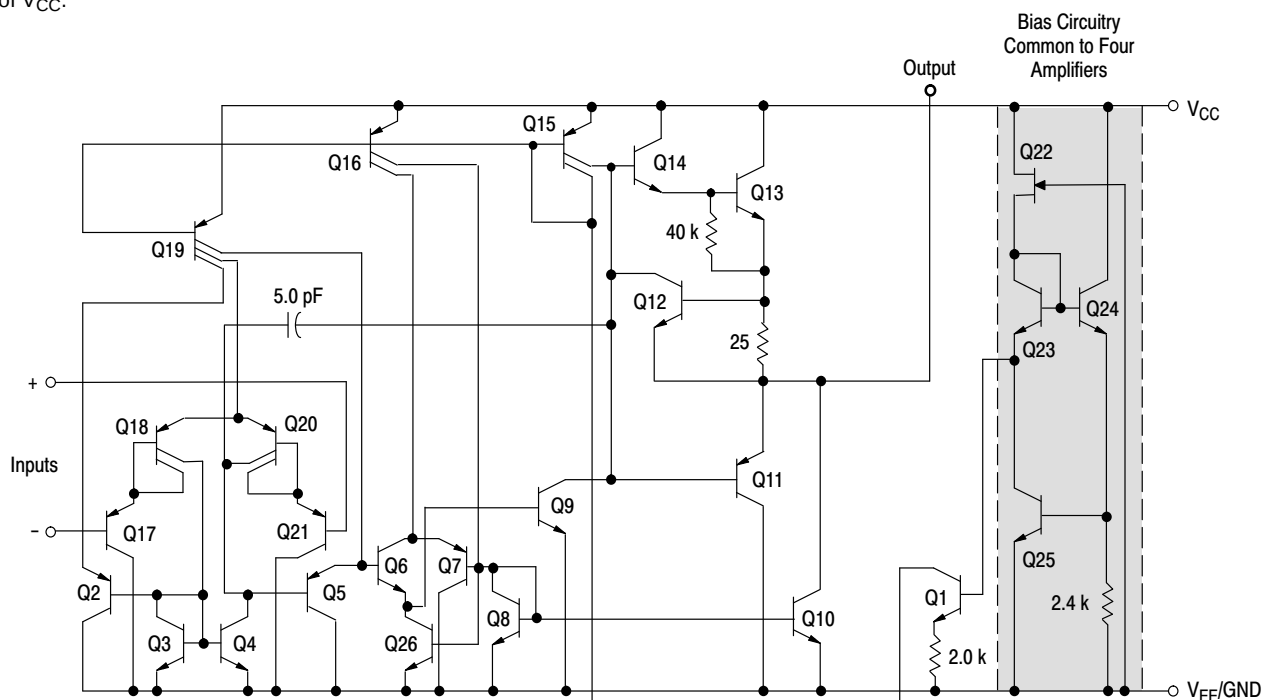


Figure 1. Representative Circuit Diagram
(One-Fourth of Circuit Shown)

LM324S, LM2902S

CIRCUIT DESCRIPTION

The LM324S and LM2902S are made using four internally compensated, two-stage operational amplifiers. The first stage of each consists of differential input devices Q20 and Q18 with input buffer transistors Q21 and Q17 and the differential to single ended converter Q3 and Q4. The first stage performs not only the first stage gain function but also performs the level shifting and transconductance reduction functions. By reducing the transconductance, a smaller compensation capacitor (only 5.0 pF) can be employed, thus saving chip area. The transconductance reduction is accomplished by splitting the collectors of Q20

and Q18. Another feature of this input stage is that the input common mode range can include the negative supply or ground, in single supply operation, without saturating either the input devices or the differential to single-ended converter. The second stage consists of a standard current source load amplifier stage.

Each amplifier is biased from an internal-voltage regulator which has a low temperature coefficient thus giving each amplifier good temperature characteristics as well as excellent power supply rejection.



Figure 2.

LM324S, LM2902S

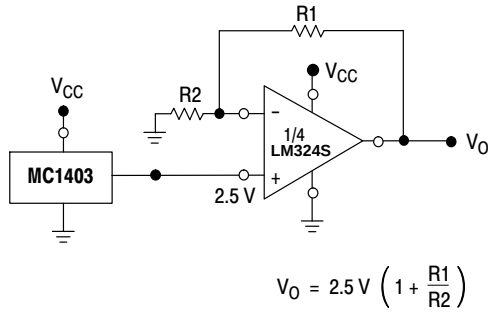


Figure 3. Voltage Reference

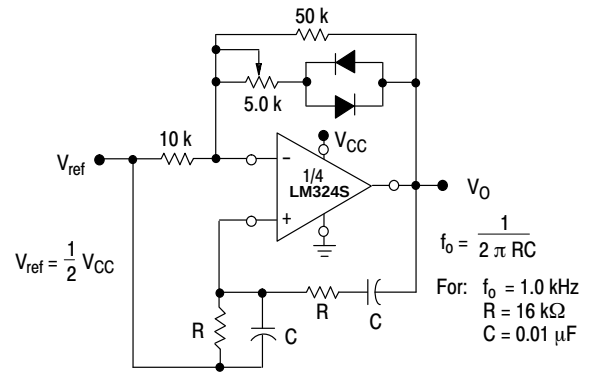


Figure 4. Wien Bridge Oscillator

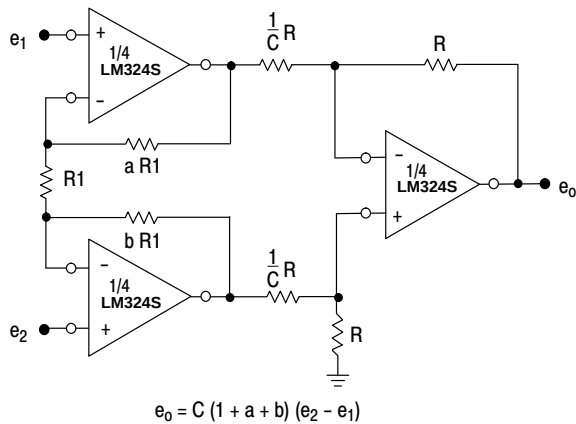


Figure 5. High Impedance Differential Amplifier

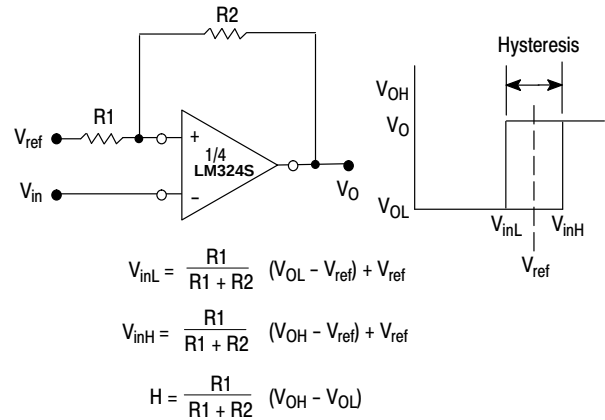


Figure 6. Comparator with Hysteresis

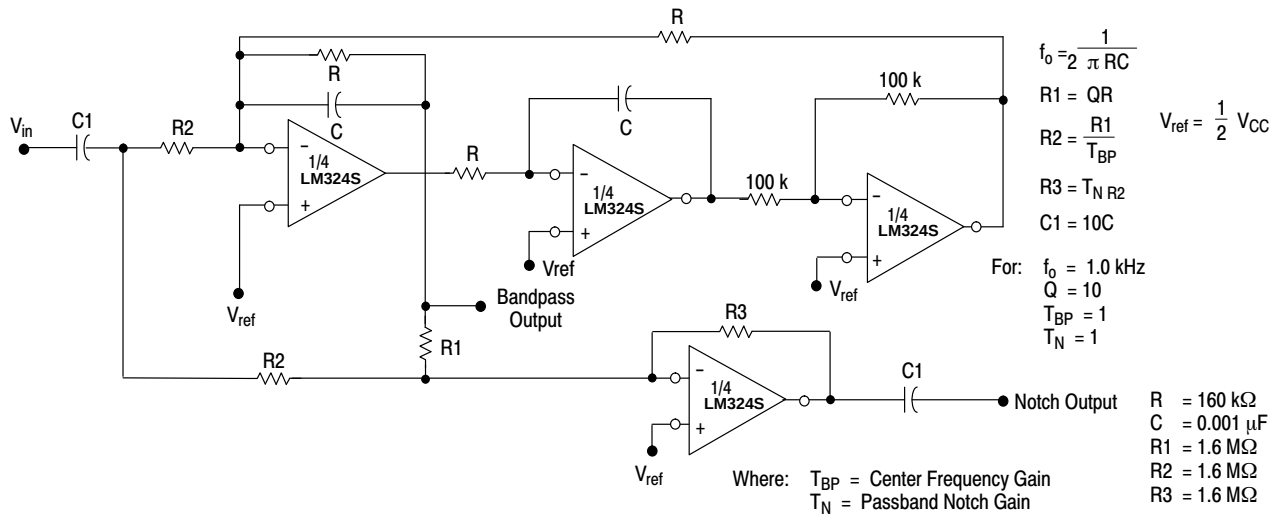


Figure 7. Bi-Quad Filter

LM324S, LM2902S

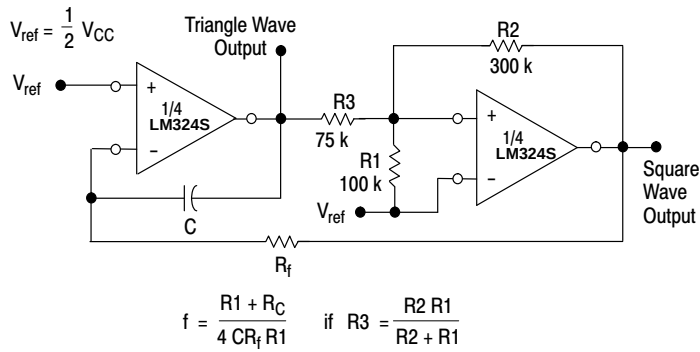


Figure 8. Function Generator

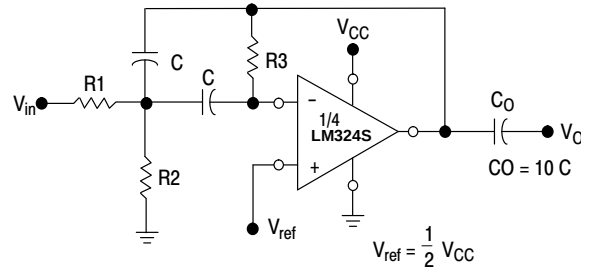


Figure 9. Multiple Feedback Bandpass Filter

Given: f_0 = center frequency
 $A(f_0)$ = gain at center frequency

Choose value f_0 , C

$$\text{Then: } R3 = \frac{Q}{\pi f_0 C}$$

$$R1 = \frac{R3}{2 A(f_0)}$$

$$R2 = \frac{R1 R3}{4 Q^2 R1 - R3}$$

For less than 10% error from operational amplifier, $\frac{Q_0 f_0}{BW} < 0.1$

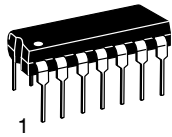
where f_0 and BW are expressed in Hz.

If source impedance varies, filter may be preceded with voltage follower buffer to stabilize filter parameters.

ORDERING INFORMATION

Device	Operating Temperature Range	Package	Shipping [†]
LM324SNG	0°C to +70°C	PDIP-14 (Pb-Free)	25 Units / Rail
LM2902SNG	-40°C to +105°C	PDIP-14 (Pb-Free)	25 Units / Rail

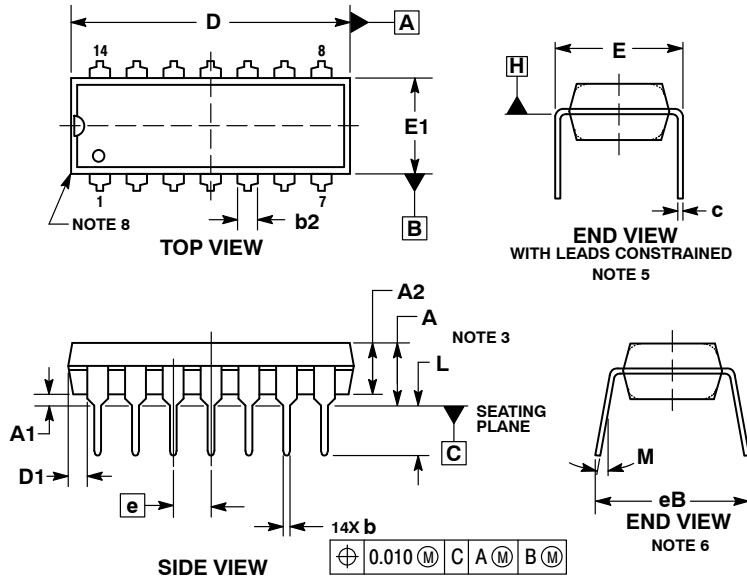
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



SCALE 1:1

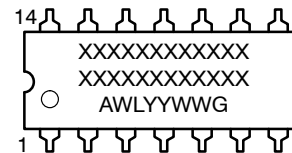
PDIP-14
CASE 646-06
ISSUE 5

DATE 22 APR 2015


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
6. DIMENSION eB IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
7. DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	0.210	---	5.33
A1	0.015	---	0.38	---
A2	0.115	0.195	2.92	4.95
b	0.014	0.022	0.35	0.56
b2	0.060 TYP 1.52 TYP			
C	0.008	0.014	0.20	0.36
D	0.735	0.775	18.67	19.69
D1	0.005	---	0.13	---
E	0.300	0.325	7.62	8.26
E1	0.240	0.280	6.10	7.11
e	0.100 BSC		2.54 BSC	
eB	---	0.430	---	10.92
L	0.115	0.150	2.92	3.81
M	---	10°	---	10°

GENERIC
MARKING DIAGRAM*


XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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STYLE 1: PIN 1. COLLECTOR 2. BASE 3. EMITTER 4. NO CONNECTION 5. EMITTER 6. BASE 7. COLLECTOR 8. COLLECTOR 9. BASE 10. EMITTER 11. NO CONNECTION 12. EMITTER 13. BASE 14. COLLECTOR	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. DRAIN 2. SOURCE 3. GATE 4. NO CONNECTION 5. GATE 6. SOURCE 7. DRAIN 8. DRAIN 9. SOURCE 10. GATE 11. NO CONNECTION 12. GATE 13. SOURCE 14. DRAIN
STYLE 5: PIN 1. GATE 2. DRAIN 3. SOURCE 4. NO CONNECTION 5. SOURCE 6. DRAIN 7. GATE 8. GATE 9. DRAIN 10. SOURCE 11. NO CONNECTION 12. SOURCE 13. DRAIN 14. GATE	STYLE 6: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 7: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 8: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 9: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE	STYLE 10: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 11: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 12: PIN 1. COMMON CATHODE 2. COMMON ANODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. COMMON ANODE 7. COMMON CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE

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